

VSTA065R44ANA

Datasheet



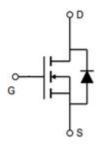


VSTA065R44ANA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D
650V	440mΩ@10V	10A

Symbol



Symbol of VSTA065R44ANA

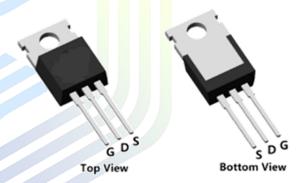
Features

- $V_{DS} = 650V, I_D = 10A$
- $\blacksquare R_{DS(ON) max} = 440 m\Omega @V_{GS} = 10V$
- Extremely low switching loss
- Excellent stability and uniformity
- RoHS and Halogen-Free Compliant

Application

- PC power
- LED lighting
- Telecom power
- Server power
- Solar/UPS

Package Type



Package Type of VSTA065R44ANA

Ordering Information

Product Name	Package	Marking		
VSTA065R44ANA	TO-220	STA065R44ANA		



VSTA065R44ANA

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current Note 1, T _C =25°C	I_D	10	A
Pulsed Drain Current Note 2, T _C =25°C	I _{D, pulse}	30	A
Continuous Diode Forward Current Note 1, T _C =25°C	I_{S}	10	A
Diode Pulsed Current Note 2, T _C =25°C	I _{S, pulse}	30	A
Max Power Dissipation Note 3, T _C =25°C	P_{D}	110	W
Avalanche Current, Single Pulse Note 4	I _{AS}	4.5	A
Avalanche Energy, Single Pulse Note4	Eas	203	mJ
MOSFET dv/dt ruggedness, V _{DS} =0~480V	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\sim480V$, $I_{SD}<=I_{D}$	dv/dt	15	V/ns
Operation and storage temperature	T _J ,T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		1.14		°C/W
Thermal Resistance, Junction-to-Ambient Note5	$R_{ heta JA}$		62		C/W

Notes:

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4: V_{DD}=50V, V_{GS}=10V, L=20mH, starting T_A=25 °C.

Note5: When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.



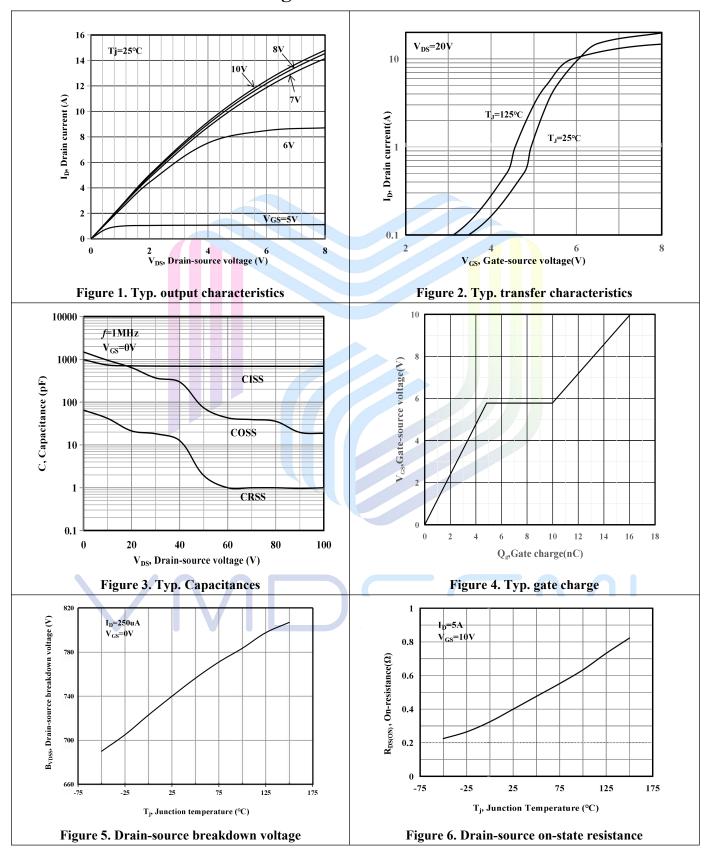
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Electrical Characteristics (T_A= 25 °C, unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit	
Statistic Characteristics								
Drain-Source Breakdown Voltage		BV_{DSS}	V _{GS} =0V, I _D =250uA	650			V	
Drain-Source Leakage Current		I_{DSS}	V _{DS} =650V, V _{GS} =0V			1	uA	
Gate-Source Leakage Current	Forward	I _{GSSF}	$V_{GS}=30V, V_{DS}=0V$			100	nA	
	Reverse	I_{GSSR}	V_{GS} =-30V, V_{DS} =0V			-100		
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	3.0		4.5	V	
Drain-Source On-State Resistance	ce	R _{DS(ON)}	$V_{GS}=10V, I_{D}=5A$		385	440	mΩ	
Gate Resistance		R_G	F=1MHz, Open Drain		5.6		Ω	
Dynamic Characteristics								
Input Capacitance		C _{iss}	$V_{DS}=100V, V_{GS}=0V,$		691		pF	
Output Capacitance		Coss	f=1MHz		73.9		pF	
Reverse Transfer Capacitance		C_{rss}	I-IIVIIIZ		1.9		pF	
Turn-on Delay Time		t _{d(on)}			17.8		ns	
Rise Time		t_r	V_{DS} =400V, I_{D} =5A,		11.0			
Turn-off Delay Time		$t_{ m d(off)}$	$R_G=25\Omega$, $V_{GS}=10V$		53.2			
Fall Time		t_{f}			44.8			
Gate Charge Characteristics								
Gate to Source Charge		Q_{gs}			4.66			
Gate to Drain Charge		Q_{gd}	V_{DS} =400V, I_{D} =5A,		5.74		nC	
Gate Charge Total		Q_{g}	$V_{GS}=0$ to $10V$		16.11			
Gate Plateau Voltage		V _{Plateau}			5.8		V	
Reverse Diode Characteristics								
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS}=0V, I_S=1A$		0.75		V	
Reverse Recovery Time		t _{rr}	- V _R =400V, I _S =5A, - di/dt=100A/us		193		ns	
Reverse Recovery Charge		Qrr			1.79		uС	
Peak Reverse Recovery Current		I _{rrm}	ui/ut=100A/us		16.26		A	



Electrical Characteristics Diagrams





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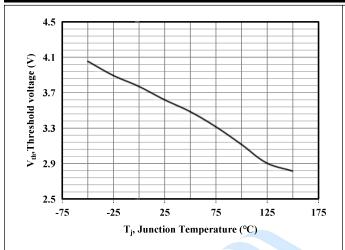


Figure 7. Threshold voltage

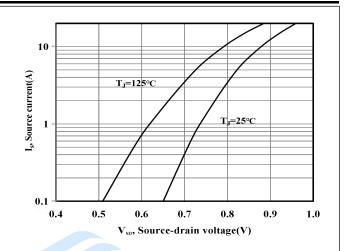


Figure 8. Forward characteristic of body diode

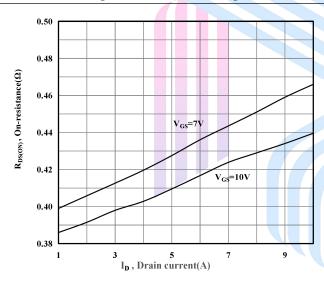


Figure 9. Drain-source on-state resistance

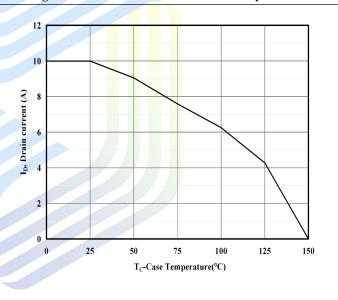
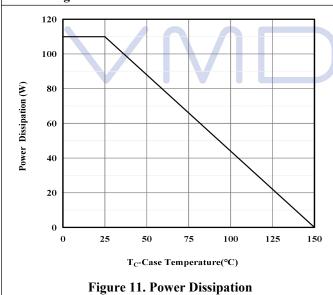


Figure 10. Drain current Derating



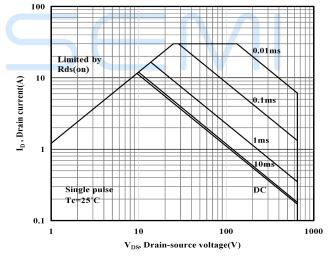
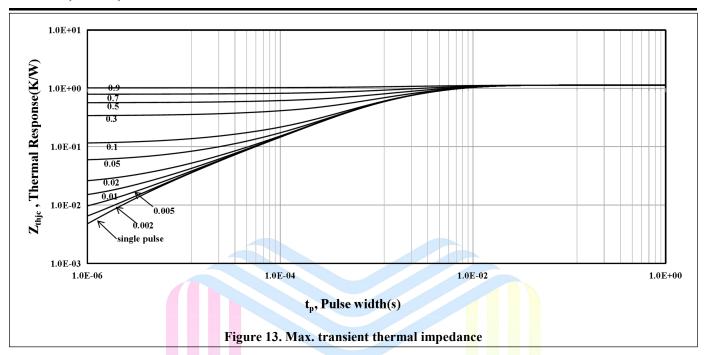
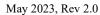


Figure 12. Safe operation area T_C=25 °C



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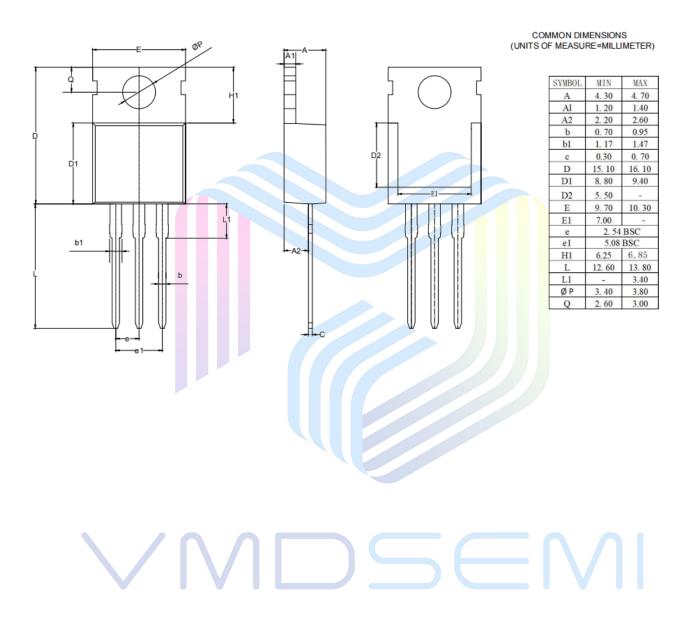




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Mechanical Dimensions

TO-220 Package Information



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